	NI NII	20170615002	DCN D	A 7	- 27 20	· ¬		
	N Number:	20170615003	PCN Da	ite: Jun	e 27, 20	1/		
Title: Datasheet for LMR23630-Q1								
Cus	stomer Contact:	PCN Manager		D	ept:	Quality Services		
Change Type:								
	Assembly Site		Design		Wafer	Bump Site		
	Assembly Process		Data Sheet		_	Bump Material		
	Assembly Material		Part number chang	je 🗆		Bump Process		
	Mechanical Specifi		Test Site			Fab Site		
	Packing/Shipping/	Labeling ⁻	Test Process			Fab Materials		
					Wafer	Fab Process		
	Notification Details							
Description of Change:								
Texas Instruments Incorporated is announcing an information only notification.								
	product datasheet			below.				
The	e following change h	nistory provides fu	irther details.					
	<u>. </u>							
7.	TEXAS					LMR23630-Q1		
`	Instruments			SNVSAR6A -	DECEMBER 2	016-REVISED APRIL 2017		
Ch	Changes from Original (December 2016) to Revision A					Page		
•	Changed the ESD HBM rating to ±2000 from ±2500							
Tho	datasheet number	will be changing						
		will be changing.	Change From:		CI			
Device Family					I (nana	2 Ta:		
	<u>-</u>		_		Change			
LM	1R23630-Q1		SNVSAR6		SNVSA			
	<u>-</u>	reviewed at the	SNVSAR6	ovided.				
The	1R23630-Q1		SNVSAR6 datasheet links pro	ovided.				
The	IR23630-Q1 ese changes may be		SNVSAR6 datasheet links pro	ovided.				
The http	IR23630-Q1 ese changes may be o://www.ti.com/pro	duct/LMR23630-0	SNVSAR6 datasheet links pro	ovided.				
The http Rea To a	R23630-Q1 ese changes may be o://www.ti.com/pro ason for Change: accurately reflect de ticipated impact of	duct/LMR23630-0 evice characteristion Fit, Form, Fur	SNVSAR6 datasheet links pro	· Reliabili	SNVSA	tive / negative):		
The http Rea To a Ant	IR23630-Q1 ese changes may be o://www.ti.com/pro ason for Change: accurately reflect de ticipated impact of anticipated impact.	duct/LMR23630-0 evice characteristion Fit, Form, Fur	SNVSAR6 datasheet links pro	· Reliabili	SNVSA	tive / negative):		
The http Rea To a Ant No a to t	ese changes may be c://www.ti.com/processon for Change: accurately reflect deticipated impact canticipated impact. The actual device.	evice characteristics on Fit, Form, Fur This is a specification	SNVSAR6 datasheet links pro 21 cs. action, Quality or ation change annotation	• Reliabili uncement	SNVSA	tive / negative):		
The http Rea To a Ant No a to t	IR23630-Q1 ese changes may be o://www.ti.com/pro ason for Change: accurately reflect de ticipated impact of anticipated impact.	evice characteristics on Fit, Form, Fur This is a specification	SNVSAR6 datasheet links pro 21 cs. action, Quality or ation change annotation	• Reliabili uncement	SNVSA	tive / negative):		
The http Rea To a Ant No a to t	IR23630-Q1 ese changes may be o://www.ti.com/pro eson for Change: accurately reflect de ticipated impact of anticipated impact. The actual device. anges to product	evice characteristics on Fit, Form, Fur This is a specification	SNVSAR6 datasheet links pro 21 cs. action, Quality or ation change annotation	• Reliabili uncement	SNVSA	tive / negative):		
The http Rea To a Ant No a to t Cha	IR23630-Q1 ese changes may be o://www.ti.com/pro eson for Change: accurately reflect de ticipated impact of anticipated impact. The actual device. anges to product	evice characteristics on Fit, Form, Fur This is a specification	SNVSAR6 datasheet links pro 21 cs. action, Quality or ation change annotation	• Reliabili uncement	SNVSA	tive / negative):		

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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